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Crust with two layers used for pizza - by pressing upper and lower crusts

together and cutting to required shape

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A 19850516 198701 B JP 61260830 A 19861119 JP 85102639 A 19850516 199311 JP 93013606 B 19930223 JP 85102639

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JP 61260830 A

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Abstract (Basic): JP 61260830 A

In the prepn. an upper crust layer comprising wheat flour, a yeast, an oil, salt and water and a lower crust layer comprising a pie mixt. as folded with margine or butter spread over the mixt. are formed into a sheet with press rollers and a moving stand, and the sheet is cut into a prescribed shape and fermented at 38 deg.C for 20 minutes.

USE - A crust of pizza pie.

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Derwent Class: D11

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